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Part Number: 0736420000
Status: Active
Overview: HDM Backplane Connector System
Description: HDM Board-to-Board Backplane Header, Vertical, Press-Fit, Open End, 72 Circuits

Documents:
[3D Model](#)
[Drawing \(PDF\)](#)
[Product Specification PS-73670-9999 \(PDF\)](#)
[Product Specification TS-73670-990-001 \(PDF\)](#)
[Packaging Specification PK-70873-0818 \(PDF\)](#)
[RoHS Certificate of Compliance \(PDF\)](#)

Agency Certification

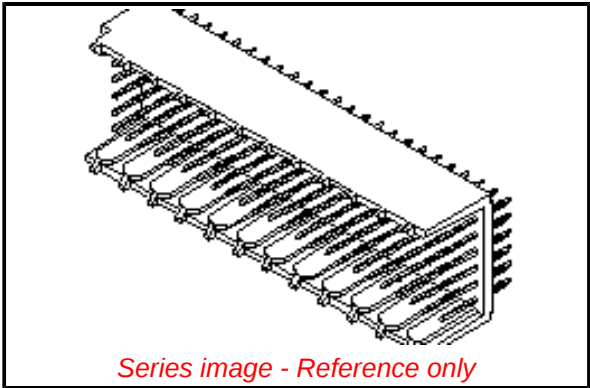
CSA LR19980
UL E29179

General

Product Family Backplane Connectors
Series 73642
Application Backplane
Comments Standard Press-Fit
Component Type PCB Header
Overview HDM Backplane Connector System
Product Name HDM
UPC 800754345057

Physical

Circuits (Loaded) 72
Circuits (maximum) 72
Color - Resin Black, Natural
Durability (mating cycles max) 250
First Mate / Last Break No
Flammability 94V-0
Guide to Mating Part No
Keying to Mating Part None
Material - Metal Phosphor Bronze
Material - Plating Mating Gold
Material - Plating Termination Gold
Material - Resin High Temperature Thermoplastic
Net Weight 3.371/g
Number of Columns 12
Number of Pairs Open Pin Field
Number of Rows 6
Orientation Vertical
PC Tail Length 3.50mm
PCB Locator No
PCB Retention Yes
PCB Thickness - Recommended 1.60mm
Packaging Type Tube
Pitch - Mating Interface 2.00mm
Pitch - Termination Interface 2.00mm
Plating min - Mating 0.762µm
Plating min - Termination 0.051µm
Polarized to PCB No
Stackable Yes
Surface Mount Compatible (SMC) Yes
Temperature Range - Operating -55° to +105°C
Termination Interface: Style Through Hole - Compliant Pin



Series image - Reference only

EU ELV

Not Relevant

EU RoHS

Compliant

China RoHS

REACH SVHC

Not Contained Per -
ED/61/2018 (27 June
2018)

Halogen-Free

Status

Low-Halogen

For more information, please visit [Contact US](#)

China ROHS Green Image
ELV Not Relevant
RoHS Phthalates Not Contained

Search Parts in this Series

73642 Series

Mates With

73632 HDM+ Board-to-Board Daughtercard
Receptacle. 73780 HDM Board-to-Board
Daughtercard Receptacle

Electrical

Current - Maximum per Contact	1.0A
Data Rate	1.0 Gbps
Real Signals (per 25mm)	75
Shielded	No
Voltage - Maximum	250V AC

Solder Process Data

Lead-freeProcess Capability	N/A
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Material Info

Reference - Drawing Numbers

Packaging Specification	PK-70873-0818
Product Specification	PS-73670-9999, TS-73670-990-001
Sales Drawing	SDA-73642-****

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